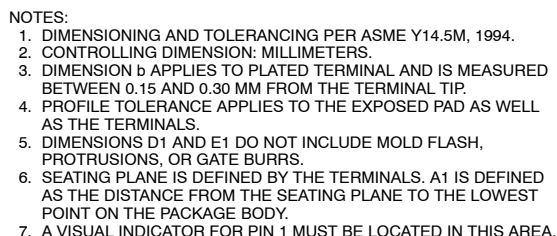


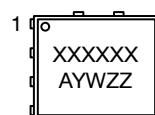
**ON**



DATE 26 FEB 2013



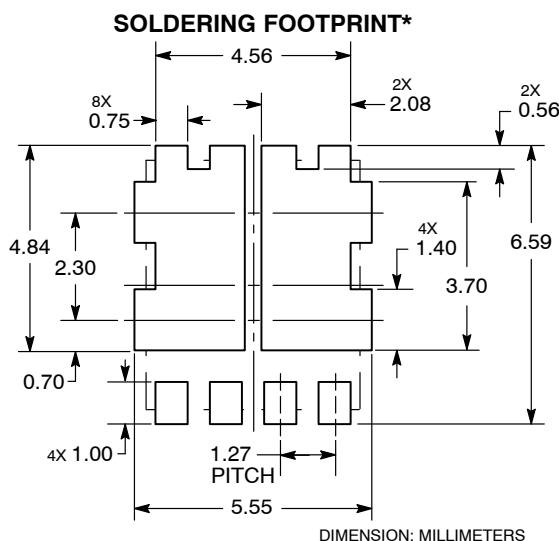
### GENERIC MARKING DIAGRAM\*



XXXXXX= Specific Device Code  
A = Assembly Location  
Y = Year  
W = Work Week  
ZZ = Lot Traceability

	MILLIMETERS		
DIM	MIN	MAX	MAX
A	0.90	-----	1.10
A1	-----	-----	0.05
b	0.33	0.42	0.51
b1	0.33	0.42	0.51
c	0.20	-----	0.33
D	5.15 BSC		
D1	4.70	4.90	5.10
D2	3.90	4.10	4.30
D3	1.50	1.70	1.90
E	6.15 BSC		
E1	5.70	5.90	6.10
E2	3.90	4.15	4.40
e	1.27 BSC		
G	0.45	0.55	0.65
h	-----	-----	12 °
K	0.51	-----	-----
K1	0.56	-----	-----
L	0.48	0.61	0.71
M	3.25	3.50	3.75
N	1.80	2.00	2.20


\*This information is generic. Please refer to device data sheet for actual part marking.



DIMENSION: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual. SOLDERRM/D.

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<b>DESCRIPTION:</b>	<b>DFN8 5X6, 1.27P DUAL FLAG (SO8FL-DUAL)</b>	<b>PAGE 1 OF 1</b>

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